

MOS FIELD EFFECT TRANSISTOR **2SK2462**

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2462 is N-Channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

Low On-Resistance

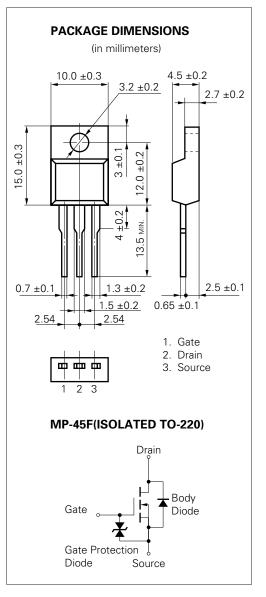
 $\begin{array}{l} {\sf R}_{\sf DS(on)1} = 0.14 \ \Omega \ {\sf MAX}. \ (@ \ {\sf V}_{\sf GS} = 10 \ {\sf V}, \ {\sf I}_{\sf D} = 8.0 \ {\sf A}) \\ {\sf R}_{\sf DS(on)2} = 0.17 \ \Omega \ {\sf MAX}. \ (@ \ {\sf V}_{\sf GS} = 4 \ {\sf V}, \ {\sf I}_{\sf D} = 8.0 \ {\sf A}) \end{array}$

- Low C_{iss} C_{iss} = 790 pF TYP.
- Built-in G-S Gate Protection Diodes
- High Avalanche Capability Ratings

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	Vdss	100	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	D(DC)	±15	А
Drain Current (pulse)*	D(pulse)	±60	А
Total Power Dissipation (T _c = 25 $^{\circ}$ C)	Ρ τ1	30	W
Total Power Dissipation (T _A = 25 $^{\circ}$ C)	Рт2	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C
Single Avalanche Current**	las	15	А
Single Avalanche Energy**	Eas	22.5	mJ
* PW \leq 10 μ s, Duty Cycle \leq 1 %			

** Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0



The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding rated voltage may be applied to this device.

ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-Resistance	RDS(on)1		0.10	0.14	Ω	Vgs = 10 V, Id = 8.0 A
Drain to Source On-Resistance	RDS(on)2		0.12	0.17	Ω	Vgs = 4 V, Id = 8.0 A
Gate to Source Cutoff Voltage	V _{GS(off)}	1.0	1.6	2.0	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	y _{fs}	7.0	14		S	Vds = 10 V, Id = 8.0 A
Drain Leakage Current	IDSS			10	μA	$V_{DS} = 100 V, V_{GS} = 0$
Gate to Source Leakage Current	Igss			±10	μA	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0$
Input Capacitance	Ciss		790		pF	V _{DS} = 10 V
Output Capacitance	Coss		280		pF	V _{GS} = 0
Reverse Transfer Capacitance	Crss		88		pF	f = 1 MHz
Turn-On Delay Time	td(on)		16		ns	ID = 8.0 A
Rise Time	tr		110		ns	$V_{GS(on)} = 10 V$
Turn-Off Delay Time	td(off)		88		ns	$V_{DD} = 50 V$
Fall Time	tr		62		ns	R _G = 10 Ω
Total Gate Charge	QG		33		nC	ID = 15 A
Gate to Source Charge	Q _{GS}		5.4		nC	V _{DD} = 80 V
Gate to Drain Charge	Qgd		25		nC	Vgs = 10 V
Body Diode Forward Voltage	VF(S-D)		1.1		V	IF = 15 A, VGS = 0
Reverse Recovery Time	trr		160		ns	I⊧ = 15 A, V _{GS} = 0
Reverse Recovery Charge	Qrr		670		nC	di/dt = 100 A/µs

Test Circuit 1 Avalanche Capability

Test Circuit 2 Switching Time

D.U.T. ¢

∿∕∿-↔ Rg

 $R_G = 10 \ \Omega$

PG

t

t = 1 μ s Duty Cycle \leq 1 %

 V_{GS}

0-

≷ R∟

TVDD

Vgs

Wave

Form

lъ

Wave

Form

 V_{GS}

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0^{1<u>0 %</u>}

10 %

0

90 %

90 %

10 %

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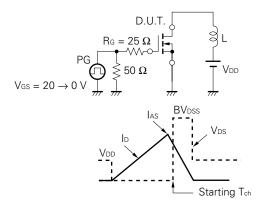
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VGS (o

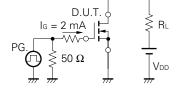
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90 %

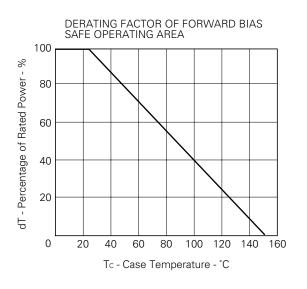
tr



Test Circuit 3 Gate Charge

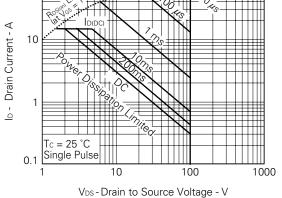


The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

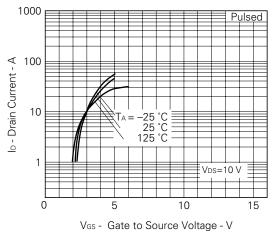


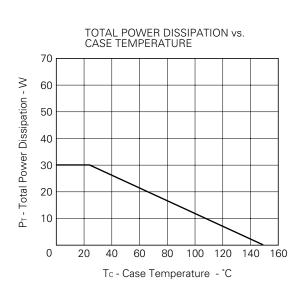
TYPICAL CHARACTERISTICS (TA = 25 °C)



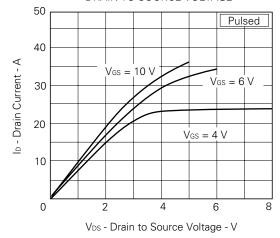


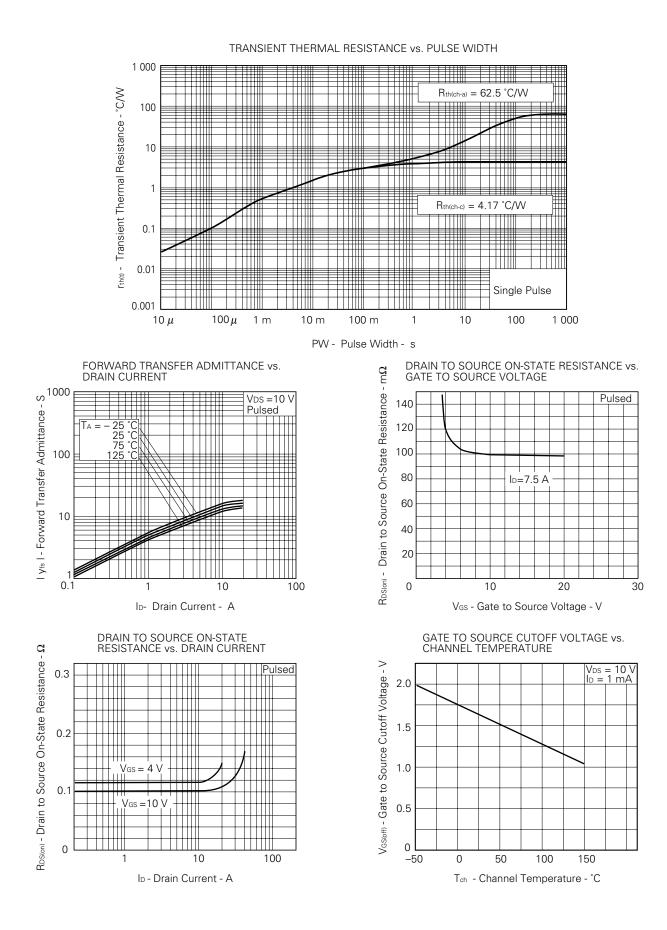


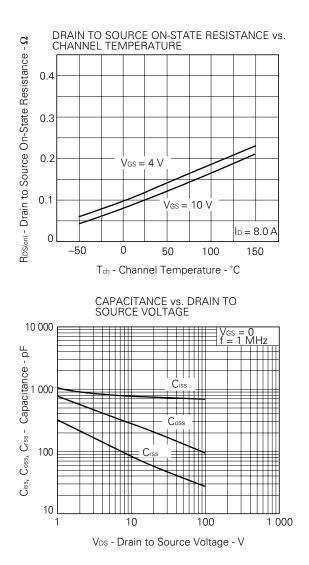


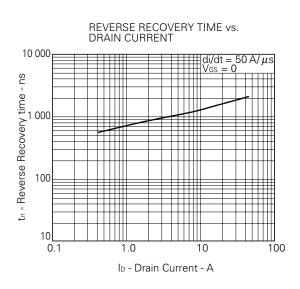


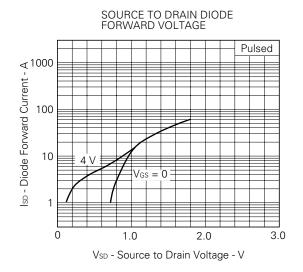
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



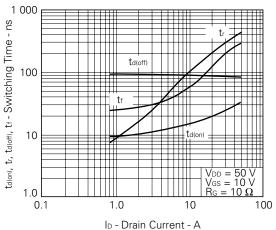


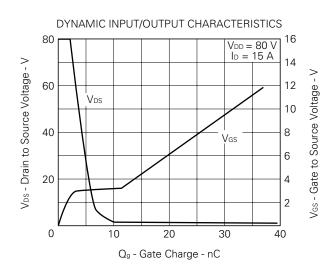


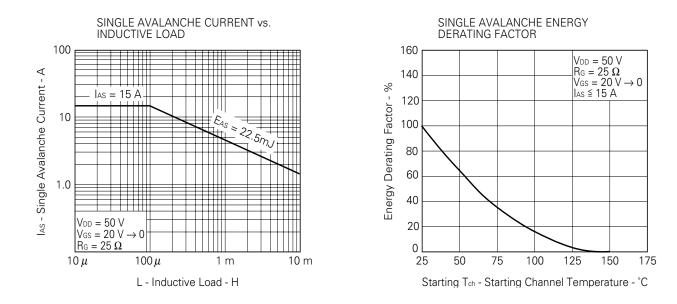












REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

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Anti-radioactive design is not implemented in this product.